

## TRENCHSTOP™ Series

# Low Loss DuoPack : IGBT in TRENCHSTOP<sup>™</sup> and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode









### Very low V<sub>CE(sat)</sub> 1.5V (typ.)

- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
- Positive temperature coefficient in V<sub>CE(sat)</sub>
- very tight parameter distribution
- high ruggedness, temperature stable behaviour
- very high switching speed
- Low EMI
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

### Applications:

- Frequency Converters
- Uninterrupted Power Supply

Туре	V <sub>CE</sub>	I <sub>C</sub>	V <sub>CE(sat),Tj=25℃</sub>	<b>T</b> <sub>j,max</sub>	Marking	Package
IKW75N60T	600V	75A	1.5V	175°C	K75T60	PG-TO247-3

#### **Maximum Ratings**

Parameter		Symbol	Value	Unit	
Collector-emitter voltage, $T_j \ge 25^{\circ}C$		V <sub>CE</sub>	600	V	
	$T_{\rm C} = 25^{\circ}{\rm C}$		80 <sup>2)</sup>		
DC collector current, limited by $T_{jmax}$	$T_{\rm C} = 100^{\circ}{\rm C}$	I <sub>C</sub>	75		
Pulsed collector current, $t_p$ limited by $T_{jmax}$		<i>I</i> <sub>Cpuls</sub>	225		
Turn off safe operating area $V_{CE} = 600V$ , $T_j = 175^{\circ}C$ , $t_p = 1\mu$ Diode forward current, limited by $T_{jmax}$ $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$		-	225		
Diada famuard aurorat limited by T	$T_{\rm C} = 25^{\circ}{\rm C}$		80 <sup>2)</sup>		
Diode forward current, limited by T <sub>jmax</sub>	$T_{\rm C} = 100^{\circ}{\rm C}$		75		
Diode pulsed current, $t_p$ limited by $T_{jmax}$	I <sub>Fpuls</sub>	225			
Gate-emitter voltage		V <sub>GE</sub>	±20	V	
Short circuit withstand time <sup>3)</sup>		4	<b>F</b>		
$V_{\text{GE}}$ = 15V, $V_{\text{CC}} \le 400$ V, $T_j \le 150^{\circ}$ C		t <sub>sc</sub>	5	μs	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$		P <sub>tot</sub>	428	W	
Operating junction temperature	Tj	-40+175			
Storage temperature		T <sub>stg</sub>	-55+150	°C	
Soldering temperature, 1.6mm (0.063 in.) fro	m case for 10s	T <sub>sold</sub>	260		

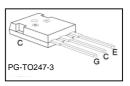
<sup>1)</sup> J-STD-020 and JESD-022

<sup>2)</sup> Value limited by bondwire

<sup>3)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.









### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				1
IGBT thermal resistance,	R <sub>thJC</sub>		0.35	K/W
junction – case				
Diode thermal resistance,	R <sub>thJCD</sub>		0.6	
junction – case				
Thermal resistance,	R <sub>thJA</sub>		40	
junction – ambient				

### **Electrical Characteristic,** at $T_j = 25$ °C, unless otherwise specified

Devementer	Cumb ol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	V <sub>(BR)CES</sub>	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	V
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$V_{\rm GE} = 15 V, I_{\rm C} = 75 A$				
		<i>T</i> <sub>j</sub> =25°C	-	1.5	2.0	
		<i>T</i> <sub>j</sub> =175°C	-	1.9	-	
Diode forward voltage	V <sub>F</sub>	$V_{\rm GE} = 0V, I_{\rm F} = 75A$				
		<i>T</i> <sub>j</sub> =25°C	-	1.65	2.0	
		<i>T</i> <sub>j</sub> =175°C	-	1.6	-	
Gate-emitter threshold voltage	V <sub>GE(th)</sub>	$I_{\rm C}$ =1.2mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I <sub>CES</sub>	V <sub>CE</sub> =600V, V <sub>GE</sub> =0V				μA
		<i>T</i> <sub>j</sub> =25°C	-	-	40	
		<i>T</i> <sub>j</sub> =175°C	-	-	5000	
Gate-emitter leakage current	I <sub>GES</sub>	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{ m fs}$	$V_{\rm CE}$ =20V, $I_{\rm C}$ =75A	-	41	-	S
Integrated gate resistor	R <sub>Gint</sub>			-		Ω

### **Dynamic Characteristic**

Input capacitance	Ciss	$V_{\rm CE}=25\rm V,$	-	4620	-	pF
Output capacitance	Coss	$V_{\rm GE}=0V$ ,	-	288	-	
Reverse transfer capacitance	Crss	f=1MHz	-	137	-	
Gate charge	Q <sub>Gate</sub>	$V_{\rm CC}$ =480V, $I_{\rm C}$ =75A	-	470	-	nC
		$V_{GE}=15V$				
Internal emitter inductance	LE		-	13	-	nH
measured 5mm (0.197 in.) from case						
Short circuit collector current	I <sub>C(SC)</sub>	$V_{GE}=15V, t_{SC}\leq 5\mu s$	-	690	-	А
Allowed number of short circuits: <1000; time between short circuits: >1s.		$V_{CC} = 400 V,$ $T_j \le 150^{\circ} C$				



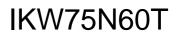
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### Switching Characteristic, Inductive Load, at $T_i$ =25 °C

Deremeter	Symbol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =25°C,	-	33	-	ns
Rise time	t <sub>r</sub>	$V_{CC}=400V, I_{C}=75A,$ $V_{GE}=0/15V,$ $r_{G}=5\Omega, L_{\sigma}=100nH,$ $C_{\sigma}=39pF$ $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	36	-	1
Turn-off delay time	t <sub>d(off)</sub>		-	330	-	
Fall time	t <sub>f</sub>		-	35	-	
Turn-on energy	Eon		-	2.0	-	mJ
Turn-off energy	E <sub>off</sub>		-	2.5	-	1
Total switching energy	Ets		-	4.5	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>j</sub> =25°C,	-	121	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	V <sub>R</sub> =400V, I <sub>F</sub> =75A,	-	2.4	-	μC
Diode peak reverse recovery current	I <sub>rrm</sub>	<i>di</i> <sub>F</sub> / <i>dt</i> =1460A/µs	-	38.5	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	921	-	A/μs

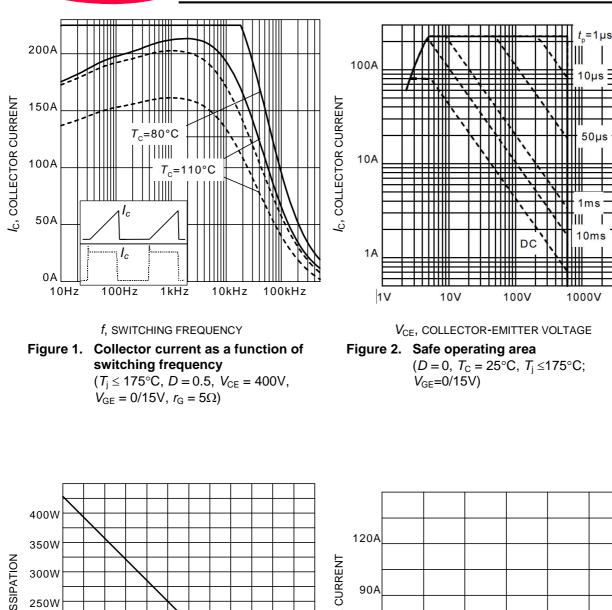
### Switching Characteristic, Inductive Load, at T<sub>j</sub>=175 °C

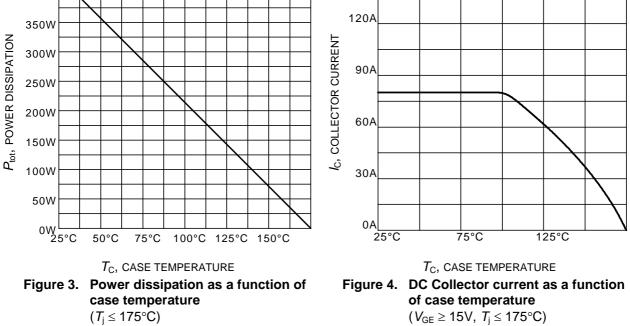
Deveryor	Cumhal	<b>O</b> an dition o	Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						•
Turn-on delay time	t <sub>d(on)</sub>	T <sub>j</sub> =175°C,	-	32	-	ns
Rise time	t <sub>r</sub>	$V_{cc}=400V, I_{c}=75A,$ $V_{GE}=0/15V,$ $r_{G}=5\Omega, L_{\sigma}=100nH,$ $C_{\sigma}=39pF$ $L_{\sigma}, C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	37	-	
Turn-off delay time	t <sub>d(off)</sub>		-	363	-	
Fall time	<i>t</i> <sub>f</sub>		-	38	-	
Turn-on energy	Eon		-	2.9	-	mJ
Turn-off energy	E <sub>off</sub>		-	2.9	-	
Total switching energy	Ets		-	5.8	-	
Anti-Parallel Diode Characteristic						•
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>j</sub> =175°C	-	182	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	V <sub>R</sub> =400V, <i>I</i> <sub>F</sub> =75A,	-	5.8	-	μC
Diode peak reverse recovery current	<i>I</i> <sub>rrm</sub>	<i>di</i> <sub>F</sub> / <i>dt</i> =1460A/µs	-	56.2	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	1013	-	A/μs





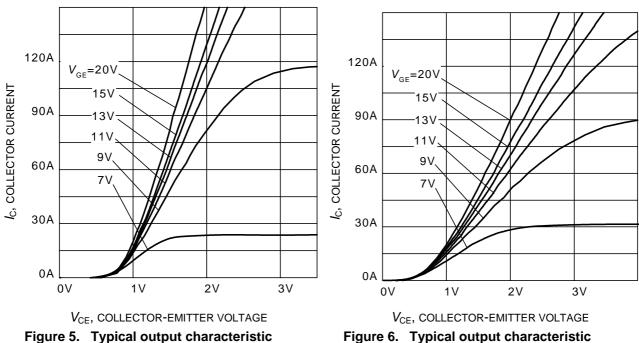
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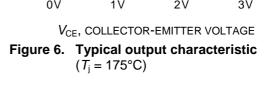


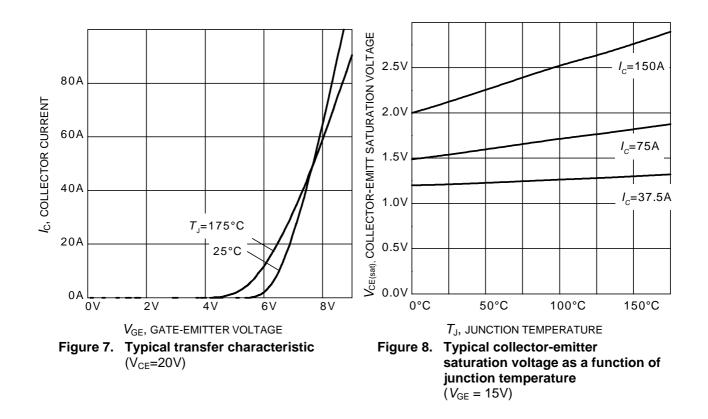




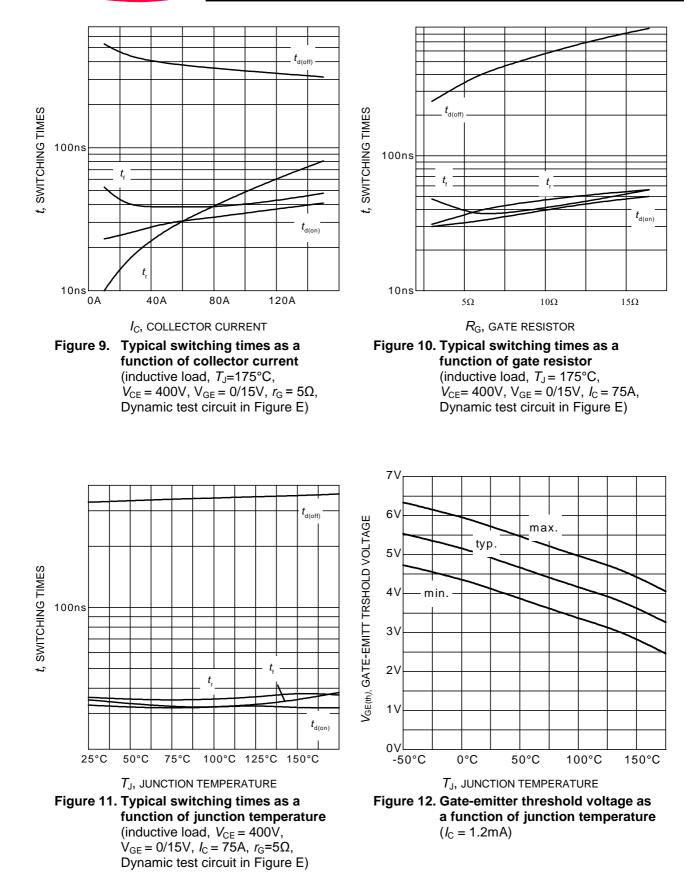


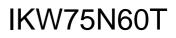




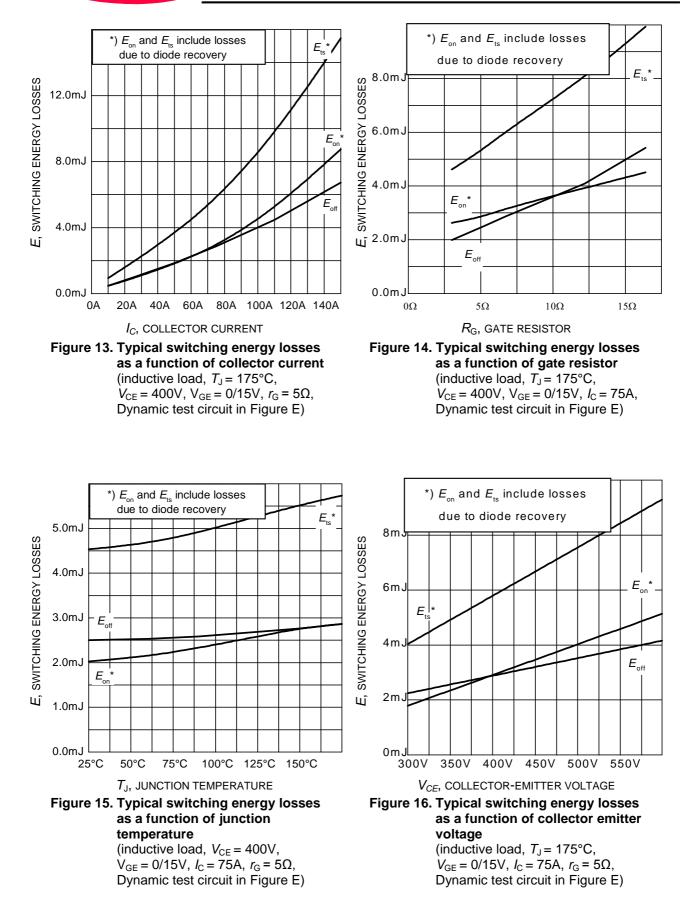






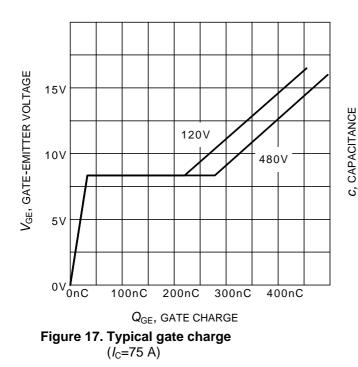


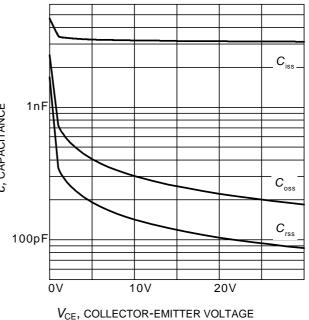


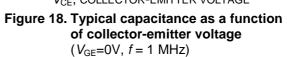


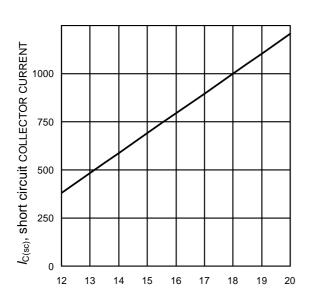


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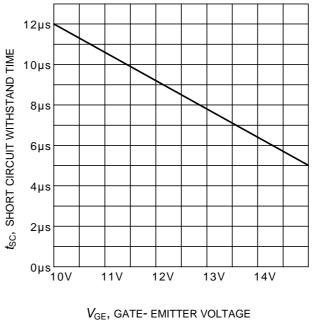


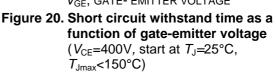




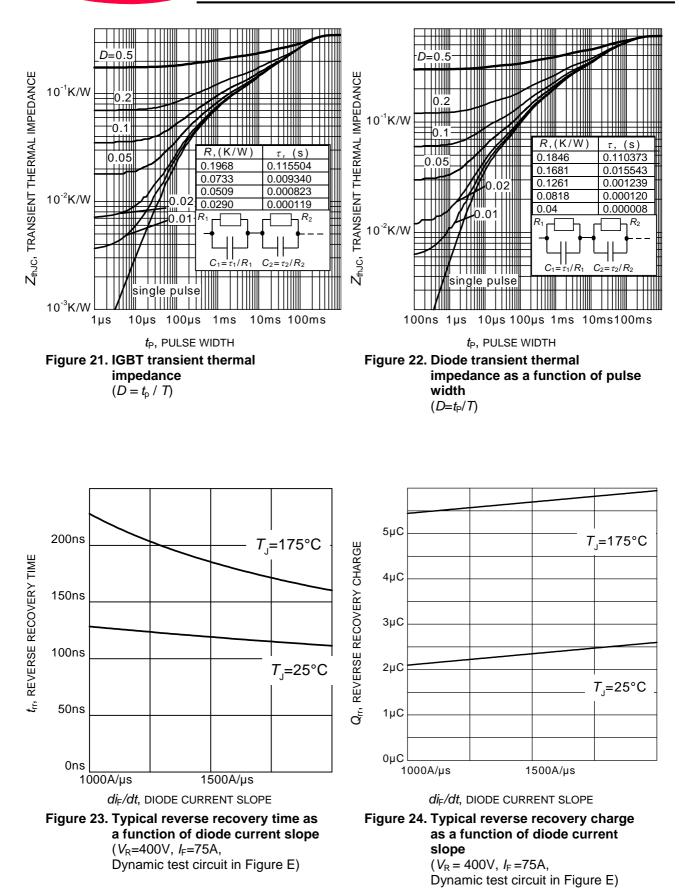


 $V_{GE}$ , GATE-EMITTER VOLTAGE Figure 19. Typical short circuit collector current as a function of gateemitter voltage  $(V_{CE} \le 400V, T_i \le 150^{\circ}C)$ 

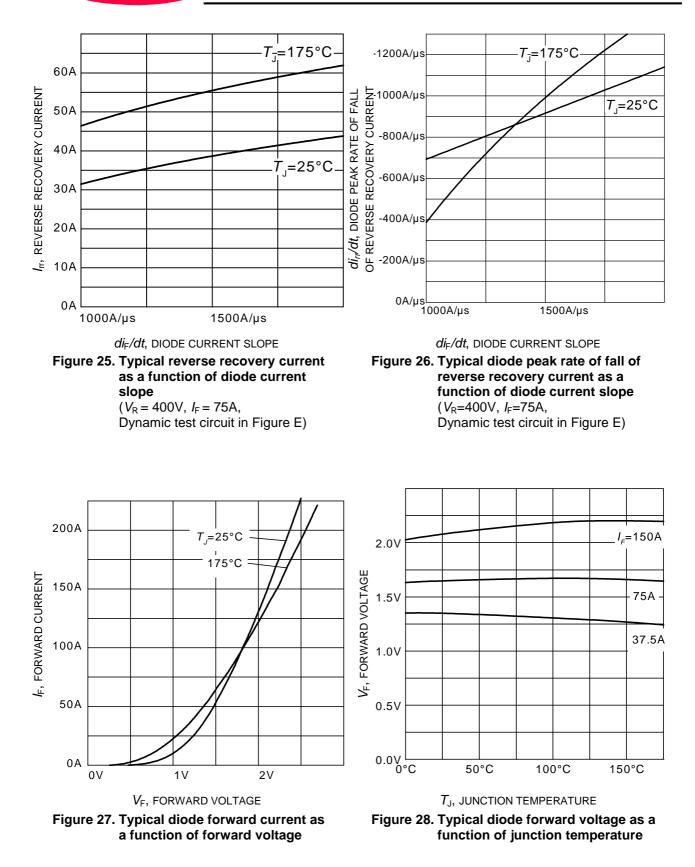


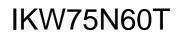




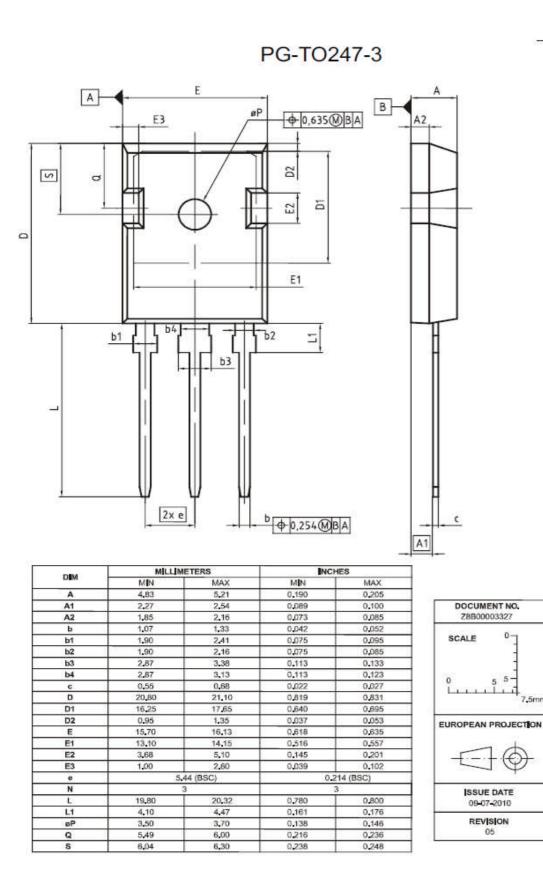








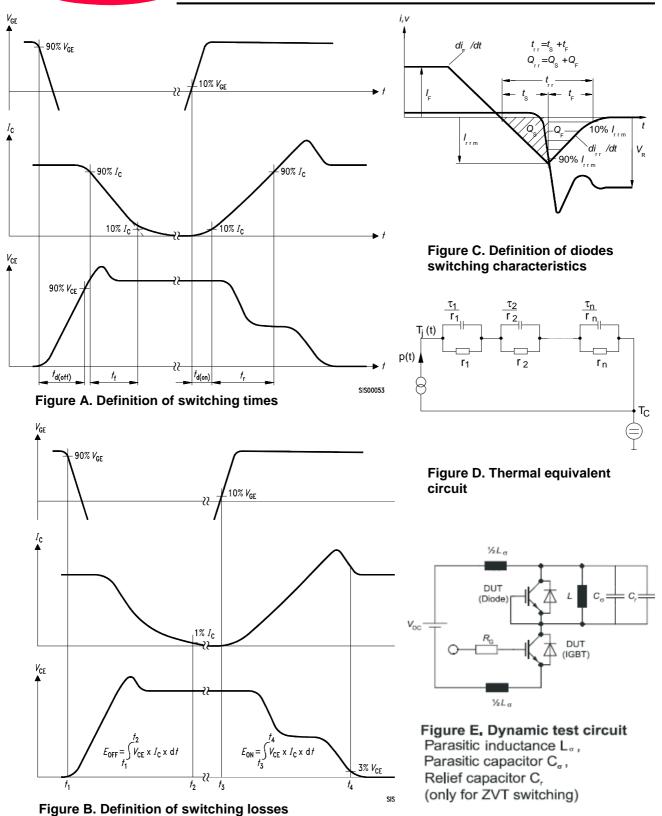




7,5mm



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